

Title (en)  
TEMPERATURE CONTROL STATION FOR PARTIALLY THERMALLY TREATING A METAL COMPONENT

Title (de)  
TEMPERIERSTATION ZUR PARTIELLEN WÄRMEBEHANDLUNG EINES METALLISCHEN BAUTEILS

Title (fr)  
POSTE DE THERMORÉGULATION POUR LE TRAITEMENT THERMIQUE PARTIEL D'UNE PIÈCE MÉTALLIQUE

Publication  
**EP 3538677 B1 20210120 (DE)**

Application  
**EP 17804826 A 20171108**

Priority  
• DE 102016121699 A 20161111  
• EP 2017078675 W 20171108

Abstract (en)  
[origin: WO2018087191A1] The invention relates to a temperature control station (1) for partially thermally treating a metal component (2), comprising a machining plane (3) which is arranged in the temperature control station (1) and on which the component (2) can be arranged, at least one nozzle (4) which is oriented towards the machining plane (3) and is provided and designed to discharge a fluid flow (5) for cooling at least one first sub-region (6) of the component (2), and at least one nozzle box (7) which is arranged above the machining plane (3). The at least one nozzle box (7) forms at least one nozzle region (8) in which the at least one nozzle (4) can be at least partly arranged and/or which at least partly delimits an expansion of the fluid flow (5). The at least one nozzle box (7) is at least partly made of a ceramic material. The aim of the invention is to provide a temperature control station and a device for thermally treating a metal component which at least partly solve the problems described with respect to the prior art. In particular, the temperature control station and the device allow a sufficiently reliable thermal confinement of thermal treatment measures partially acting on the component and/or a sufficiently reliable thermal separation of different thermal treatment measures partially acting on the component.

IPC 8 full level  
**C21D 9/00** (2006.01); **C21D 1/18** (2006.01); **C21D 1/34** (2006.01); **C21D 1/673** (2006.01); **C21D 8/02** (2006.01); **C21D 11/00** (2006.01); **F27B 9/12** (2006.01); **F27D 15/00** (2006.01); **F27D 15/02** (2006.01)

CPC (source: EP US)  
**C21D 1/18** (2013.01 - EP US); **C21D 1/34** (2013.01 - EP US); **C21D 1/673** (2013.01 - EP US); **C21D 8/0294** (2013.01 - EP); **C21D 9/0062** (2013.01 - EP US); **C21D 11/005** (2013.01 - EP); **F27D 15/00** (2013.01 - EP); **F27D 15/02** (2013.01 - EP); **C21D 2221/00** (2013.01 - EP); **C21D 2221/01** (2013.01 - EP US); **C21D 2221/02** (2013.01 - EP); **C21D 2221/10** (2013.01 - EP); **F27B 2009/124** (2013.01 - EP); **F27B 2009/126** (2013.01 - EP); **F27B 2009/128** (2013.01 - EP); **F27D 2009/0089** (2013.01 - US)

Citation (examination)  
• JP 2015080786 A 20150427 - ASTEER CO LTD  
• US 2011303328 A1 20111215 - KONDO MASAAKI [JP], et al

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)  
**WO 2018087191 A1 20180517**; CN 109963951 A 20190702; CN 109963951 B 20220128; DE 102016121699 A1 20180517; EP 3538677 A1 20190918; EP 3538677 B1 20210120; ES 2863679 T3 20211011; HU E053656 T2 20210728; JP 2020501010 A 20200116; JP 7211942 B2 20230124; PL 3538677 T3 20210712; PT 3538677 T 20210323; US 11142807 B2 20211012; US 2020232053 A1 20200723

DOCDB simple family (application)  
**EP 2017078675 W 20171108**; CN 201780069864 A 20171108; DE 102016121699 A 20161111; EP 17804826 A 20171108; ES 17804826 T 20171108; HU E17804826 A 20171108; JP 2019524318 A 20171108; PL 17804826 T 20171108; PT 17804826 T 20171108; US 201716348442 A 20171108